2SD1750, 2SD1750A

Silicon NPN triple diffusion planar type Darlington

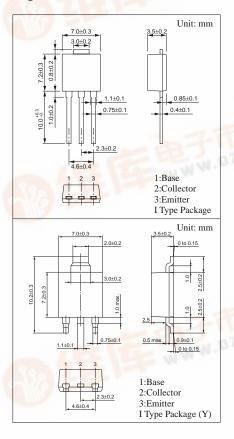
For midium speed power switching Complementary to 2SB1180 and 2SB1180A

Features

- High foward current transfer ratio h_{FE}
- High-speed switching
- I type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment.

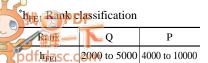
Absolute Maximum Ratings (T_C=25°C)

Parameter		Symbol	Ratings	Unit			
Collector to	2SD1750	3.7	60	V			
base voltage	2SD1750A	V_{CBO}	80				
Collector to	2SD1750	**	60	V			
emitter voltage	2SD1750A	V_{CEO}	80				
Emitter to base voltage		V_{EBO}	7	V			
Peak collector current		I_{CP}	12	A			
Collector current		I_{C}	8	A			
Collector power	T _C =25°C	D	15	W			
dissipation	Ta=25°C	P_{C}	1.3				
Junction temperature		T _j	150	°C			
Storage temperature		T_{stg}	-55 to +150	°C			
		-	3-711	C.COP			
■ Electrical Characteristics (T _C =25°C)							

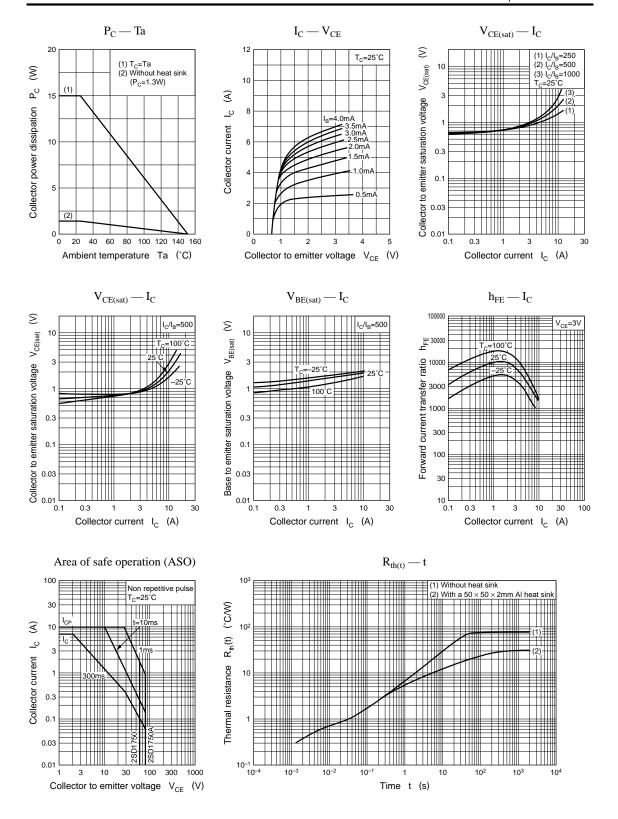


Electrical Characteristics (T_C=25°C)

Parameter		Symbol	Conditions	min	typ	max	Unit
Collector cutoff	2SD1750	T	$V_{CB} = 60V, I_{E} = 0$	60V, $I_E = 0$		100	
current	2SD1750A	I _{CBO}	$V_{CB} = 80V, I_{E} = 0$			100	μА
Emitter cutoff current		I _{EBO}	$V_{EB} = 7V, I_C = 0$			2	mA
Collector to emitter	2SD1750	37	$I_{\rm C} = 30 {\rm mA}, I_{\rm B} = 0$	60		- W	V
voltage	2SD1750A	V_{CEO}		80			
Forward current transfer ratio		h _{FE1} *	$V_{CE} = 3V, I_C = 4A$	2000		10000	
		h _{FE2}	$V_{CE} = 3V, I_{C} = 8A$	500			
Collector to emitter saturation voltage		V _{CE(sat)}	$I_C = 4V$, $I_B = 8mA$			1.5	V
Base to emitter saturation voltage		V _{BE(sat)}	$I_C = 4V$, $I_B = 8mA$			2	V
Transition frequency		f_T	$V_{CE} = 10V, I_{C} = 0.5A, f = 1MHz$		20		MHz
Turn-on time		t _{on}			0.5		μs
Storage time		t _{stg}	$I_C = 4A, I_{B1} = 8mA, I_{B2} = -8mA$		4		μs
Fall time		t _f			1		μs







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